



Institut luxembourgeois de la normalisation
de l'accréditation, de la sécurité et qualité
des produits et services

ILNAS-EN 60749-5:2017

**Semiconductor devices - Mechanical
and climatic test methods - Part 5:
Steady-state temperature humidity
bias life test**

Halbleiterbauelemente - Mechanische
und klimatische Prüfverfahren - Teil 5:
Lebensdauerprüfung bei konstanter
Temperatur und Feuchte unter

Dispositifs à semiconducteurs - Méthodes
d'essais mécaniques et climatiques -
Partie 5: Essai continu de durée de vie
sous température et humidité avec

07/2017



National Foreword

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English Version

**Semiconductor devices - Mechanical and climatic test methods -
Part 5: Steady-state temperature humidity bias life test
(IEC 60749-5:2017)**

Dispositifs à semiconducteurs - Méthodes d'essais
mécaniques et climatiques - Partie 5: Essai continu de
durée de vie sous température et humidité avec polarisation
(IEC 60749-5:2017)

Halbleiterbauelemente - Mechanische und klimatische
Prüfverfahren - Teil 5: Lebensdauerprüfung bei konstanter
Temperatur und Feuchte unter elektrischer Beanspruchung
(IEC 60749-5:2017)

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Avenue Marnix 17, B-1000 Brussels

European foreword

The text of document 47/2367/FDIS, future edition 2 of IEC 60749-5, prepared by IEC/TC 47 "Semiconductor devices" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 60749-5:2017.

The following dates are fixed:

- latest date by which the document has to be (dop) 2018-02-15
implemented at national level by
publication of an identical national
standard or by endorsement
- latest date by which the national (dow) 2020-05-15
standards conflicting with the
document have to be withdrawn

This document supersedes EN 60749-5:2003.

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The text of the International Standard IEC 60749-5:2017 was approved by CENELEC as a European Standard without any modification.

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60749-4	-	Semiconductor devices - Mechanical and climatic test methods - Part 4: Damp heat, steady state, highly accelerated stress test (HAST)	EN 60749-4	-



INTERNATIONAL STANDARD

**Semiconductor devices – Mechanical and climatic test methods –
Part 5: Steady-state temperature humidity bias life test**

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